



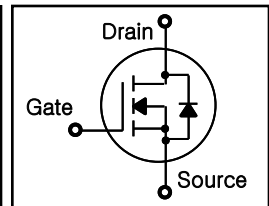
PFU60R540G / PFD60R540G

N-Channel Super Junction MOSFET

FEATURES

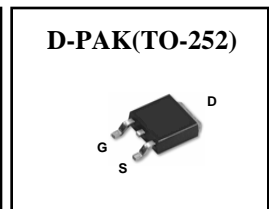
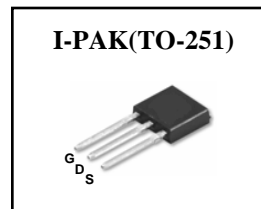
- New technology for high voltage device
- Low $R_{DS(on)}$ low conduction losses
- Small package
- Ultra low gate charge cause lower driving requirement
- 100% avalanche tested
- Halogen Free

$BV_{DSS} = 600\text{ V}$
 $R_{DS(on)} = 0.48\ \Omega$
 $I_D = 8.0\text{ A}$



APPLICATION

- Power Factor Correction(PFC)
- Switched mode power supply (SMPS)
- Uninterruptible Power Supply (UPS)



Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise specified

| Symbol | Parameter | Value | Units |
|-----------------|--|-------------|---------------------|
| V_{DS} | Drain-Source Voltage ($V_{GS}=0\text{V}$) | 600 | V |
| I_D | Drain Current – Continuous ($T_c = 25^\circ\text{C}$) | 8.0 | A |
| | Drain Current – Continuous ($T_c = 100^\circ\text{C}$) | 5.2 | A |
| $I_{DM(pulse)}$ | Drain Current – Pulsed * Note 1 | 24 | A |
| V_{GS} | Gate-Source Voltage ($V_{DS}=0\text{V}$) | ± 30 | V |
| E_{AS} | Single Pulsed Avalanche Energy * Note 2 | 185 | mJ |
| I_{AR} | Avalanche Current * Note 1 | 4.0 | A |
| E_{AR} | Repetitive Avalanche Energy * Note 1 | 0.4 | mJ |
| dv/dt | Drain Source Voltage Slope, $V_{DS} \leq 480\text{V}$ | 50 | V/ns |
| | Reverse Diode dv/dt, $V_{DS} \leq 480\text{V}$ | 15 | V/ns |
| P_D | Maximum Power Dissipation ($T_c = 25^\circ\text{C}$) | 80 | W |
| | Derate above 25°C | 0.64 | W/ $^\circ\text{C}$ |
| T_I, T_{STG} | Operating and Storage Temperature Range | -55 to +150 | $^\circ\text{C}$ |

* Limited by maximum junction temperature

Thermal Resistance Characteristics

| Symbol | Parameter | Value | Units |
|-----------------|-------------------------------|-------|--------------------|
| $R_{\theta JC}$ | Junction-to-Case (Maximum) | 1.56 | $^\circ\text{C/W}$ |
| $R_{\theta JA}$ | Junction-to-Ambient (Maximum) | 62 | |

PFU60R540G / PFD60R540G

Electrical Characteristics $T_A=25\text{ }^\circ\text{C}$ unless otherwise specified

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Units |
|---|---|--|-----|------|------|---------------|
| On Characteristics | | | | | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$ | 2.5 | 3.0 | 3.5 | V |
| $R_{DS(on)}$ | Static Drain-Source On-Resistance | $V_{GS} = 10\text{ V}, I_D = 4.0\text{ A}$ | -- | 480 | 540 | m.ohm |
| Off Characteristics | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$ | 600 | -- | -- | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = 600\text{ V}, V_{GS} = 0\text{ V}$ | -- | -- | 1 | μA |
| | | $V_{DS} = 600\text{ V}, T_C = 125\text{ }^\circ\text{C}$ | -- | -- | 100 | μA |
| I_{GSSF} | Gate-Body Leakage Current, Forward | $V_{GS} = 30\text{ V}, V_{DS} = 0\text{ V}$ | -- | -- | 100 | nA |
| I_{GSSR} | Gate-Body Leakage Current, Reverse | $V_{GS} = -30\text{ V}, V_{DS} = 0\text{ V}$ | -- | -- | -100 | nA |
| Dynamic Characteristics | | | | | | |
| g_{FS} | Forward Transconductance | $V_{DS} = 20\text{ V}, I_D = 4.0\text{ A}$ | -- | 5.5 | -- | S |
| R_G | Intrinsic Gate Resistance | $f = 1.0\text{ MHz}$, open drain | -- | 2 | -- | ohm |
| C_{iss} | Input Capacitance | $V_{DS} = 50\text{ V}, V_{GS} = 0\text{ V},$ $f = 1.0\text{ MHz}$ | -- | 680 | -- | pF |
| C_{oss} | Output Capacitance | | -- | 58 | -- | pF |
| C_{riss} | Reverse Transfer Capacitance | | -- | 4 | -- | pF |
| Q_g | Total Gate Charge | $V_{DS} = 480\text{ V}, I_D = 8.0\text{ A},$ $V_{GS} = 10\text{ V}$ | -- | 14.5 | 22 | nC |
| Q_{gs} | Gate-Source Charge | | -- | 2.8 | -- | nC |
| Q_{gd} | Gate-Drain Charge | | -- | 5.5 | -- | nC |
| Switching Characteristics | | | | | | |
| $t_{d(on)}$ | Turn-On Time | $V_{DS} = 380\text{ V}, I_D = 4.0\text{ A},$ $R_G = 12\text{ }\Omega, V_{GS} = 10\text{ V}$ | -- | 5.5 | -- | ns |
| t_r | Turn-On Rise Time | | -- | 3.5 | -- | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | | -- | 55 | 75 | ns |
| t_f | Turn-Off Fall Time | | -- | 6.5 | 10 | ns |
| Source-Drain Diode Maximum Ratings and Characteristics | | | | | | |
| I_S | Continuous Source-Drain Diode Forward Current | | -- | -- | 8.0 | A |
| I_{SM} | Pulsed Source-Drain Diode Forward Current | | -- | -- | 23.4 | |
| V_{SD} | Source-Drain Diode Forward Voltage | $I_S = 8.0\text{ A}, V_{GS} = 0\text{ V}$ | -- | 0.9 | 1.2 | V |
| t_{rr} | Reverse Recovery Time | $I_S = 8.0\text{ A}$ | -- | 220 | -- | ns |
| Q_{rr} | Reverse Recovery Charge | $di/dt = 100\text{ A}/\mu\text{s}$ | -- | 2.2 | -- | μC |

Notes ;

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. $V_{DD}=50\text{ V}, R_G=25\text{ }\Omega$, Starting $T_J=25\text{ }^\circ\text{C}$

Typical Characteristics

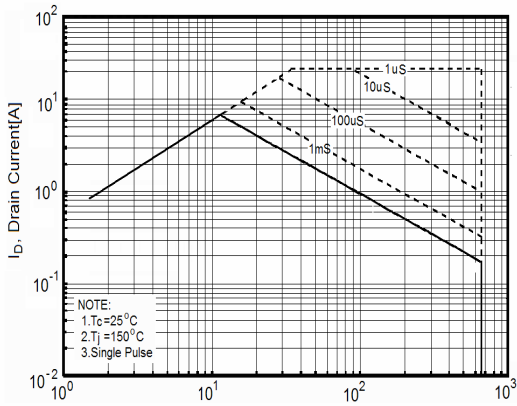


Figure 1. Safe Operating Area

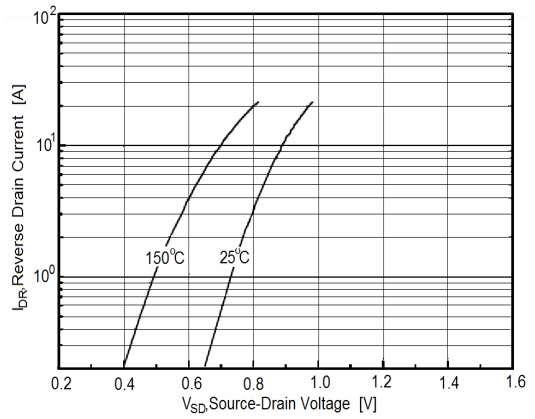


Figure 2. Source-Drain Diode Forward Voltage

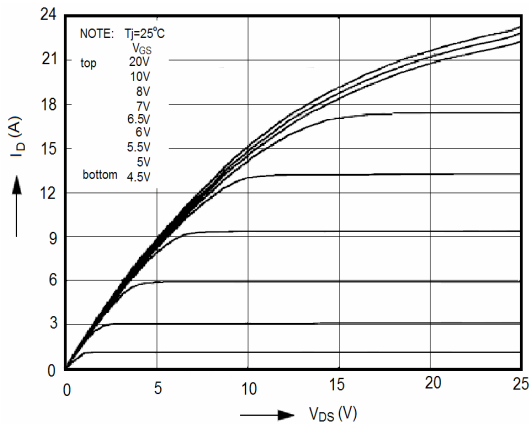


Figure 3. Output Characteristics

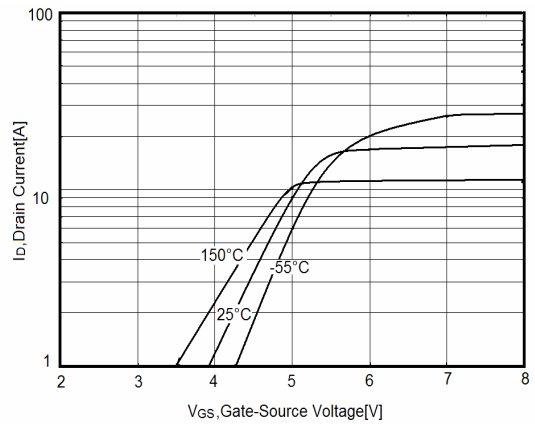


Figure 4. Transfer Characteristics

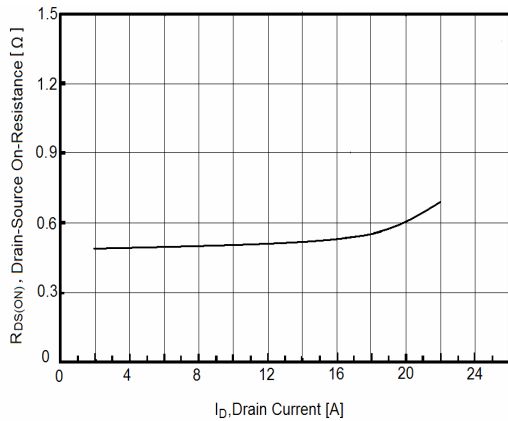


Figure 5. Static Drain-Source On Resistance

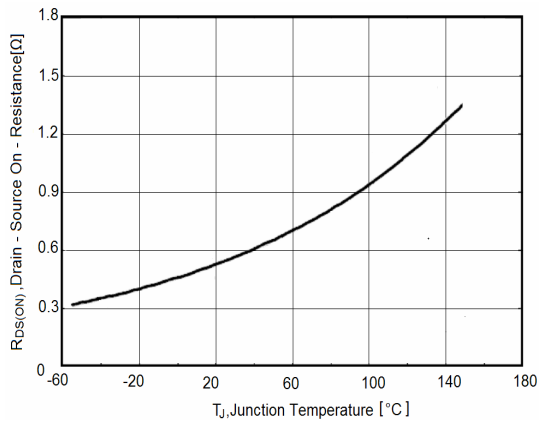


Figure 6. $R_{ds(on)}$ vs. Junction Temperature

Typical Characteristics (continued)

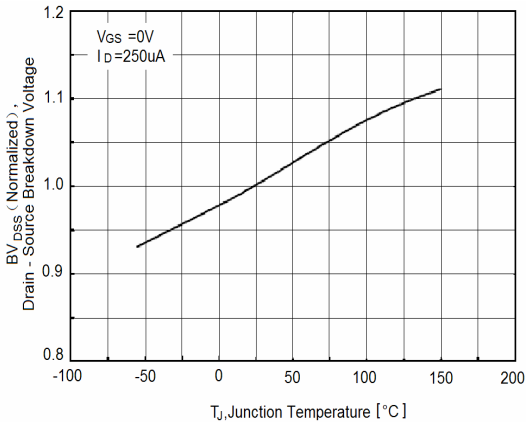


Figure 7. BVDSS vs. Junction Temperature

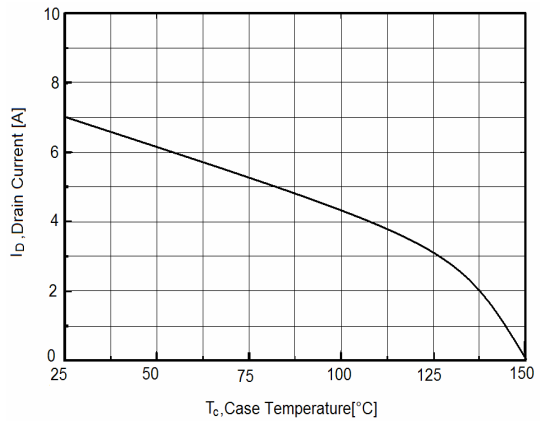


Figure 8. Maximum ID vs. Junction Temperature

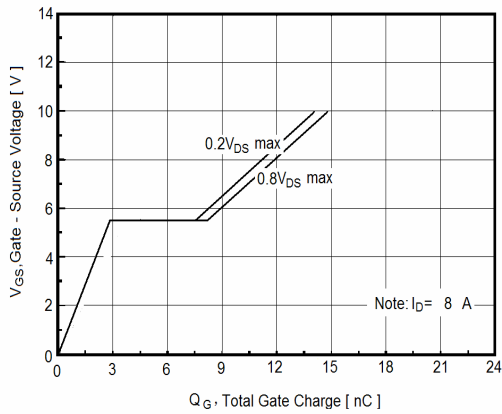


Figure 9. Gate Charge Waveforms

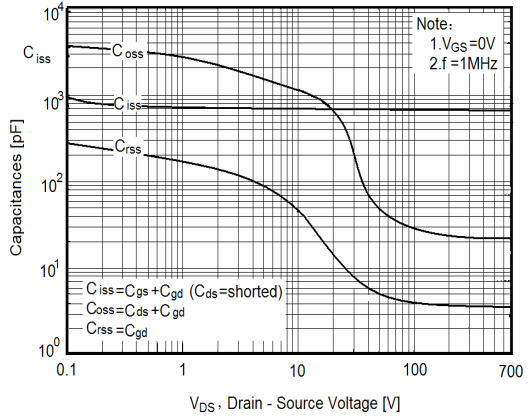


Figure 10. Capacitance

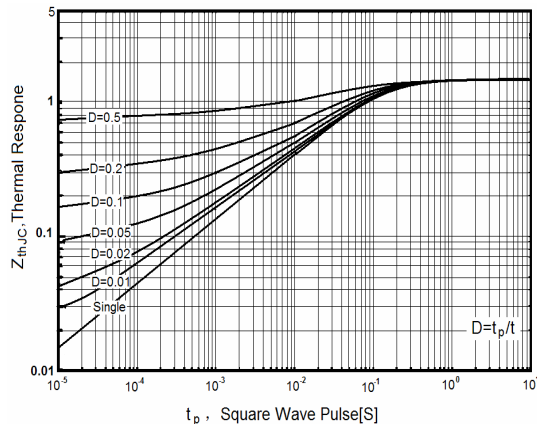
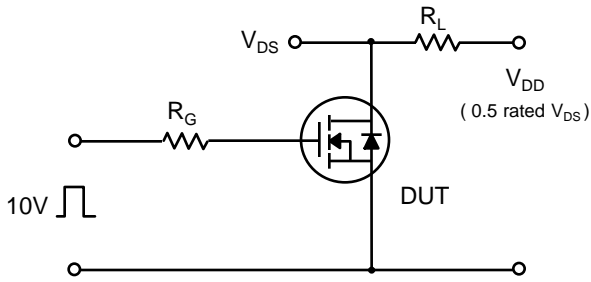
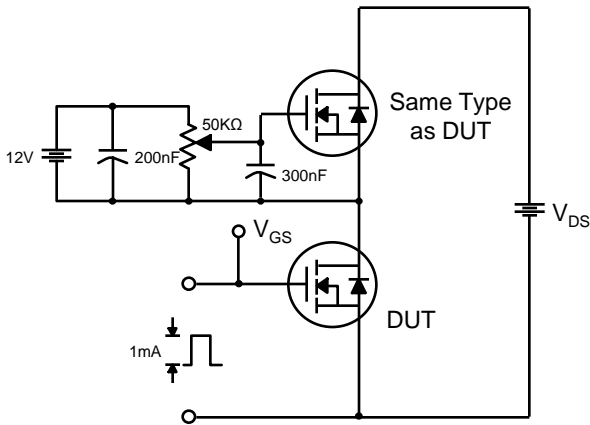


Figure 11. Transient Thermal Response Curve

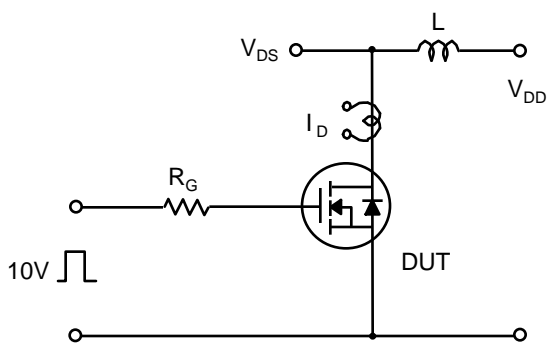
Characteristics Test Circuit & Waveform



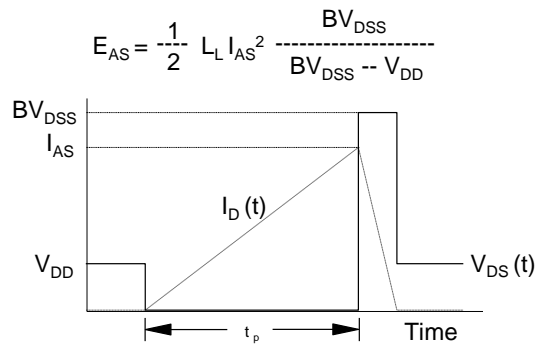
Switching Time Test Circuit & Waveforms



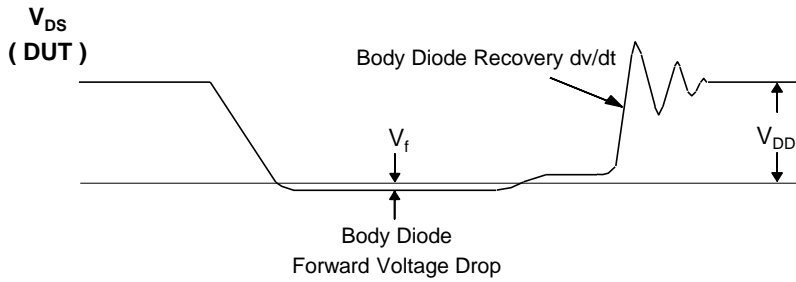
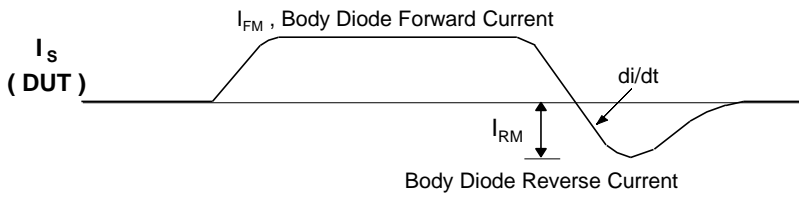
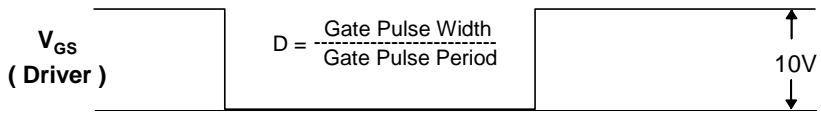
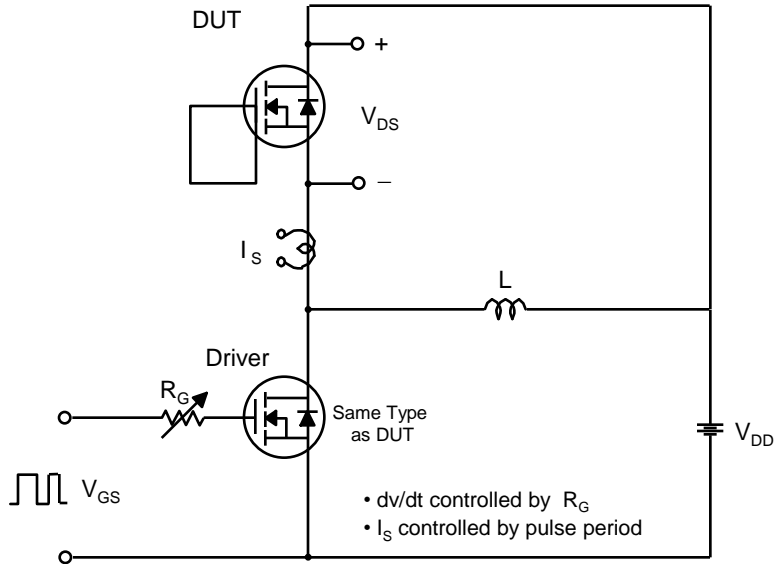
Gate Charge Test Circuit & Waveform



Unclamped Inductive Switching Test Circuit & Waveforms



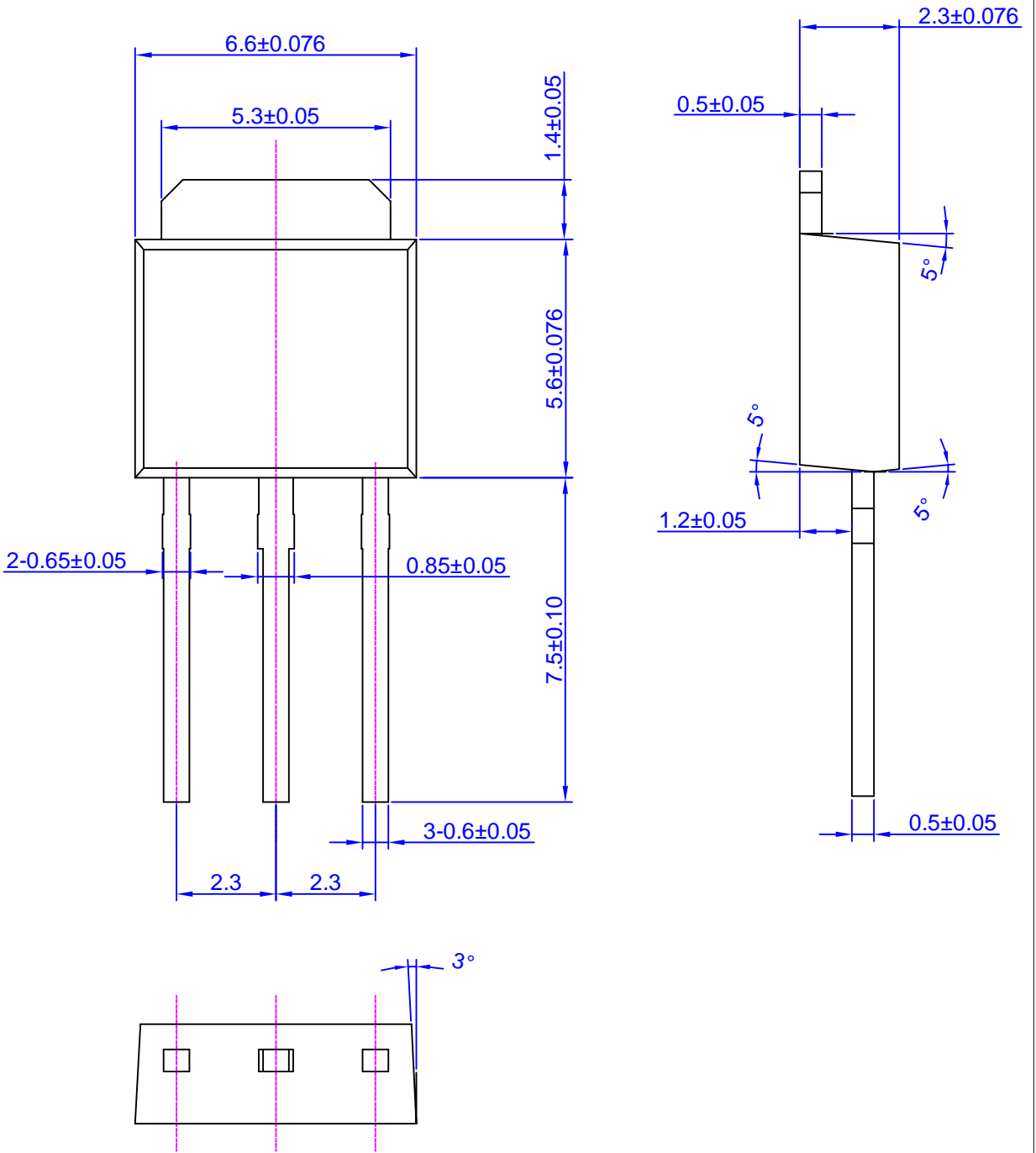
Characteristics Test Circuit & Waveform (continued)



Peak Diode Recovery dv/dt Test Circuit & Waveforms

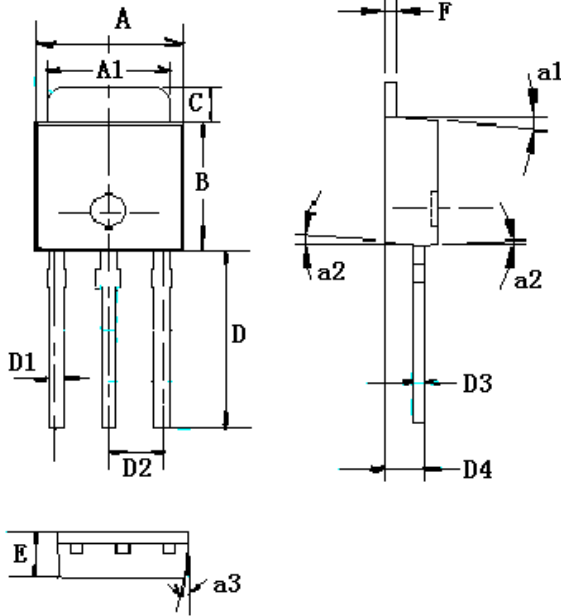
Package Dimension

I-PAK(TO-251) Type 1



Package Dimension

I-PAK(TO-251) Type 2



| Symbol | Dimensions (mm) |
|------------|-----------------|
| A | 6.40~6.60 |
| A1 | 5.30~5.50 |
| B | 5.40~5.70 |
| C | 1.35~1.65 |
| D | 7.40~8.00 |
| D1 | 0.60~0.75 |
| D2 | 2.30 |
| D3 | 0.49~0.59 |
| D4 | 1.72~1.82 |
| E | 2.20~2.40 |
| F | 0.55~0.65 |
| $\alpha 1$ | 5 |
| $\alpha 2$ | 5 |
| $\alpha 3$ | 2 |

Package Dimension

D-PAK(TO-252) Type 1

